## HEHLENT TECHNICAL DATA SHEET

 PURGING COMPOUND
## AG GRADE

## Mechanical Purging Compound for Injection Molding \& Extrusion



AG Grade is available in:

- 250 lb . poly-bags (pictured above)
- 1,200 lb. gaylords


PICTURED: Close-up of AG Grade

## Product Safety

Refer to Safety Data Sheets for more information
Have a Question? Visit asaclean.com or call 800.787.4348 to speak with a purging expert.

## Description \& Benefits

- Superior cleaning power
- Lower-residue formulation
- General purpose
- Designed for color \& material changes
- Glass-filled
- No chemical reaction
- No soak time required

| Usage Information |  |
| ---: | :--- |
| Temperature Range: | $200^{\circ} \mathrm{C}$ to $300^{\circ} \mathrm{C}\left(390^{\circ} \mathrm{F}\right.$ to $\left.570^{\circ} \mathrm{F}\right)$ |
| Minimum Clearance: | Please speak to a Technical Sales Representative for <br> further information on hot runner gate and extrusion <br> die clearances. |
| Amount of Purge: | Typically $1-2$ system capacities (actual amount <br> depends on degree of contamination) |
| Applications: | lnjection Molding <br> Extrusion - profile, sheet, cast film \& compounding |
| Types of Resin: | Most commodity and engineering resins within <br> the processing temperature range |

Physical \& Chemical Properties

| Physical Form: | Solid |
| ---: | :--- |
| Shape: | Pellets |
| Color: | White, translucent or colorless |
| Water Solubility: | Insoluble |
| Sther Solvent Solubility: | Soluble in methyl ethyl ketone, cyclohexanone, etc. <br> (except for inorganic content) |
| Reactivity: | Stable under normal temperatures |
| Non-reactive under normal handling and storage conditions |  |
| Conditions to Avoid: | Do not exceed recommended temperature range. <br> Do not allow ASACLEAN AG grade to reside in barrel for ANY <br> period of time at ANY temperature. |
| Key Measurements |  |
| Specific Gravity: | Value |
| Softening Point: | M to 1.25 at $23^{\circ} \mathrm{C}\left(73^{\circ} \mathrm{F}\right)$ |

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[^0]:    Please Note: The above data should be used for reference only.

